INTEGRATED CIRCUITS

DATA SHEET



PCA9554/PCA9554A 8-bit I²C and SMBus I/O port with interrupt

Product data Supersedes data of 2002 May 13





8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A



FEATURES

- Operating power supply voltage range of 2.3 to 5.5 V
- 5 V tolerant I/Os
- Polarity inversion register
- Active low interrupt output
- Low stand-by current
- Noise filter on SCL/SDA inputs
- No glitch on power-up
- Internal power-on reset
- 8 I/O pins which default to 8 inputs
- 0 to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JESDEC Standard JESD78 which exceeds 100 mA
- Four packages offered: SO16, SSOP16, TSSOP16, and HVQFN16

DESCRIPTION

The PCA9554 and PCA9554A are 16-pin CMOS devices that provide 8 bits of General Purpose parallel Input/Output (GPIO) expansion for I²C/SMBus applications and were developed to enhance the Philips family of I²C I/O expanders. The improvements include higher drive capability, 5V I/O tolerance, lower supply current, individual I/O configuration, 400 kHz clock frequency, and smaller packaging. I/O expanders provide a simple solution when additional I/O is needed for ACPI power switches, sensors, pushbuttons, LEDs, fans, etc..

The PCA9554/54A consist of an 8-bit Configuration register (Input or Output selection); 8-bit Input register, 8-bit Output register and an 8-bit Polarity inversion register (Active high or Active low operation). The system master can enable the I/Os as either inputs or outputs by writing to the I/O configuration bits. The data for each Input or Output is kept in the corresponding Input or Output register. The polarity of the read register can be inverted with the Polarity Inversion Register. All registers can be read by the system master. Although pin to pin and I²C address compatible with the PCF8574 series, software changes are required due to the enhancements and are discussed in Application Note AN469.

The PCA9554/54A open-drain interrupt output is activated when any input state differs from its corresponding input port register state and is used to indicate to the system master that an input state has changed. The power-on reset sets the registers to their default values and initializes the device state machine.

Three hardware pins (A0, A1, A2) vary the fixed I^2C address and allow up to eight devices to share the same $I^2C/SMBus$. The PCA9554A is identical to the PCA9554 except that the fixed I^2C address is different allowing up to sixteen of these devices (eight of each) on the same $I^2C/SMBus$.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	TOPSIDE MARK	DRAWING NUMBER
16-Pin Plastic SO (wide)	–40 to +85 °C	PCA9554D	PCA9554D	SOT162-1
16-Pin Plastic SSOP	–40 to +85 °C	PCA9554DB	9554DB	SOT338-1
16-Pin Plastic TSSOP	–40 to +85 °C	PCA9554PW	9554DH	SOT403-1
16-Pin Plastic HVQFN	–40 to +85 °C	PCA9554BS	9554	SOT629-1
16-Pin Plastic SO (wide)	–40 to +85 °C	PCA9554AD	PCA9554AD	SOT162-1
16-Pin Plastic SSOP	–40 to +85 °C	PCA9554ADB	9554A	SOT338-1
16-Pin Plastic TSSOP	–40 to +85 °C	PCA9554APW	9554ADH	SOT403-1
16-Pin Plastic HVQFN	–40 to +85 °C	PCA9554ABS	554A	SOT629-1

Standard packing quantities and other packaging data are available at www.philipslogic.com/packaging.

I²C is a trademark of Philips Semiconductors Corporation.

SMBus as specified by the Smart Battery System Implementers Forum is a derivative of the Philips I²C patent.

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

PIN CONFIGURATION — SO, SSOP, TSSOP

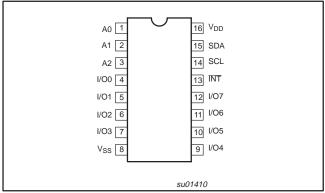


Figure 1. Pin configuration — SO, SSOP, TSSOP

PIN CONFIGURATION — HVQFN

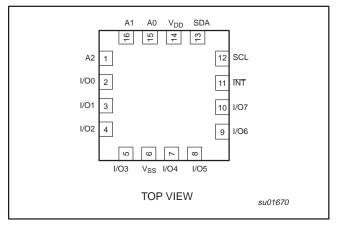


Figure 2. Pin Configuration — HVQFN

PIN DESCRIPTION

SO. SSOP, TSSOP PIN NUMBER	HVQFN PIN NUMBER	SYMBOL	FUNCTION
1	15	A0	Address input 0
2	16	A1	Address input 1
3	1	A2	Address input 2
4–7	2–5	I/O0–3	I/O0 to I/O3
8	6	V _{SS}	Supply ground
9	7–10	I/O4–7	I/O4 to I/O7
13	11	ĪNT	Interrupt output (open drain)
14	12	SCL	Serial clock line
15	13	SDA	Serial data line
16	14	V_{DD}	Supply voltage

BLOCK DIAGRAM

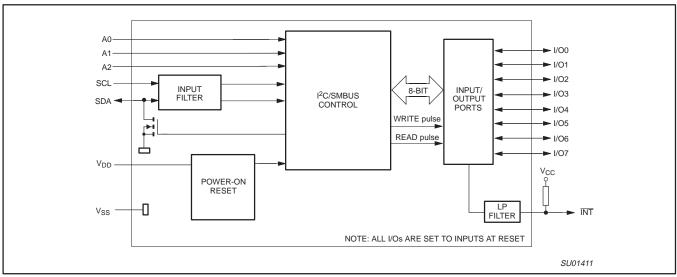


Figure 3. Block diagram

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

REGISTERS Command Byte

Command	Protocol	Function
0	Read byte	Input port register
1	Read/write byte	Output port register
2	Read/write byte	Polarity inversion register
3	Read/write byte	Configuration register

The command byte is the first byte to follow the address byte during a write transmission. It is used as a pointer to determine which of the following registers will be written or read.

Register 0 - Input Port Register

bit	17	16	15	14	13	l2	l1	10
default	1	1	1	1	1	1	1	1

This register is a read only port. It reflects the incoming logic levels of the pins, regardless of whether the pin is defined as an input or an output by Register 3. Writes to this register have no effect.

Register 1 – Output Port Register

bit	07	O6	O5	04	О3	O2	01	00
default	1	1	1	1	1	1	1	1

This register reflects the outgoing logic levels of the pins defined as outputs by Register 3. Bit values in this register have no effect on pins defined as inputs. Reads from this register return the value that is in the flip-flop controlling the output selection, NOT the actual pin value.

Register 2 - Polarity Inversion Register

bit	N7	N6	N5	N4	N3	N2	N1	N0
default	0	0	0	0	0	0	0	0

This register allows the user to invert the polarity of the Input Port Register data. If a bit in this register is set (written with '1'), the corresponding Input Port data is inverted. If a bit in this register is cleared (written with a '0'), the Input Port data polarity is retained.

Register 3 - Configuration Register

bit	C7	C6	C5	C4	C3	C2	C1	C0
default	1	1	1	1	1	1	1	1

This register configures the directions of the I/O pins. If a bit in this register is set, the corresponding port pin is enabled as an input with high impedance output driver. If a bit in this register is cleared, the corresponding port pin is enabled as an output. At reset, the I/Os are configured as inputs with a weak pull-up to V_{DD} .

Power-on Reset

When power is applied to V_{DD} , an internal power-on reset holds the PCA9554 in a reset state until V_{DD} has reached V_{POR} . At that point, the reset condition is released and the PCA9554 registers and state machine will initialize to their default states.

Interrupt Output

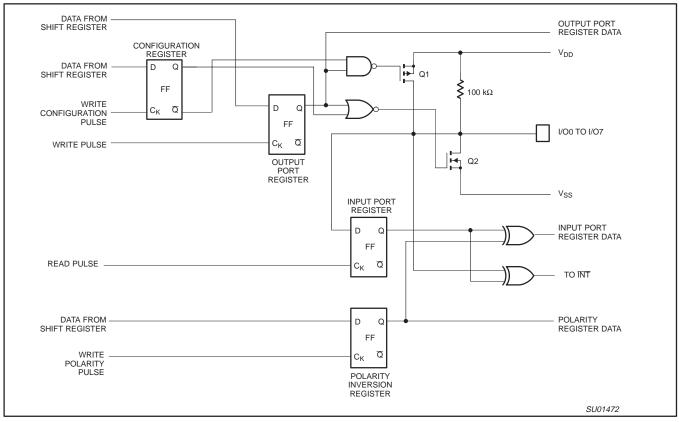
The open-drain interrupt output is activated when one of the port pins change state and the pin is configured as an input. The interrupt is deactivated when the input returns to its previous state or the input port register is read.

Note that changing an I/O from an output to an input may cause a false interrupt to occur if the state of the pin does not match the contents of the input port register.

8-bit I²C and SMBus I/O port with interrupt

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SIMPLIFIED SCHEMATIC OF I/O0 TO I/O7



NOTE: At Power-on Reset, all registers return to default values.

Figure 4. Simplified schematic of I/O0 to I/O7

I/O port

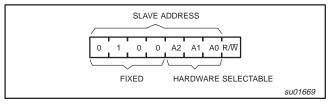
When an I/O is configured as an input, FETs Q1 and Q2 are off, creating a high impedance input with a weak pull-up (100 k Ω typ.) to V_{DD}. The input voltage may be raised above V_{DD} to a maximum of 5.5 V

If the I/O is configured as an output, then either Q1 or Q2 is enabled, depending on the state of the output port register. Care should be exercised if an external voltage is applied to an I/O configured as an output because of the low impedance paths that exist between the pin and either $V_{\mbox{\scriptsize DD}}$ or $V_{\mbox{\scriptsize SS}}.$

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

Device address



slave address

0 1 1 1 A2 A1 A0 R/W

fixed programmable su01418

Figure 5. PCA9554 address

Figure 6. PCA9554A address

Bus transactions

Data is transmitted to the PCA9554/PCA9554A registers using the write mode as shown in Figures 7 and 8. Data is read from the PCA9554/PCA9554A registers using the read mode as shown in Figures 9 and 10. These devices do not implement an auto-increment function so once a command byte has been sent, the register which was addressed will continue to be accessed by reads until a new command byte has been sent.

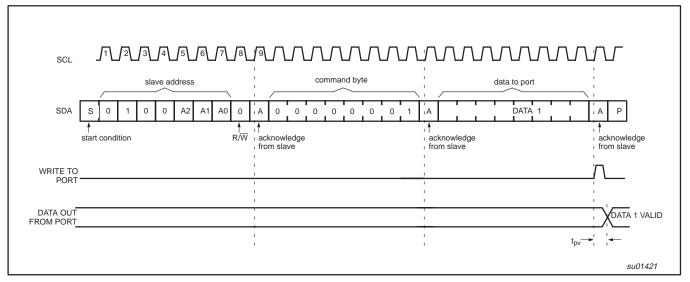


Figure 7. WRITE to output port register

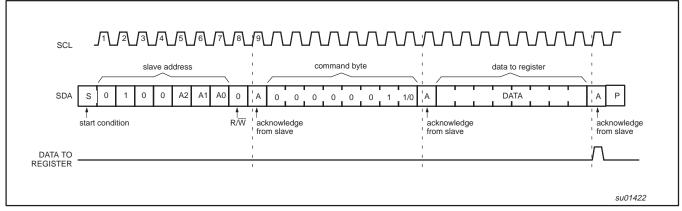


Figure 8. WRITE to configuration or polarity inversion registers

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

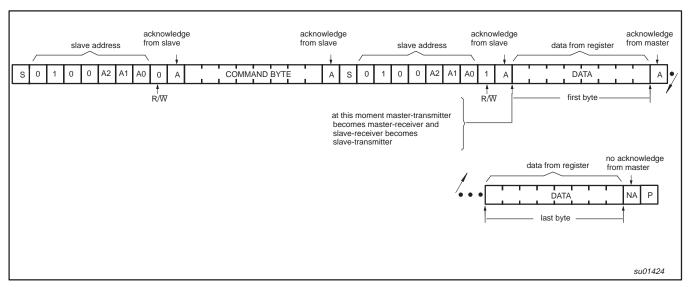
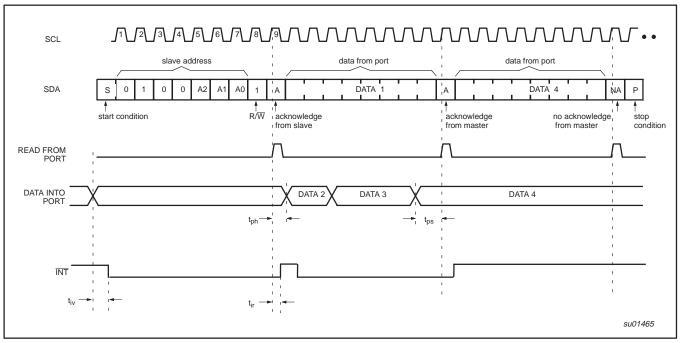


Figure 9. READ from register



NOTES:

- 1. This figure assumes the command byte has previously been programmed with 00h.
- 2. Transfer of data can be stopped at any moment by a stop condition.

Figure 10. READ input port register

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V_{DD}	Supply voltage		-0.5	6.0	V
lı	DC input current			±20	mA
V _{I/O}	DC voltage on an I/O		V _{SS} - 0.5	5.5	V
I _{I/O}	DC output current on an I/O			±50	mA
I_{DD}	Supply current		_	85	mA
I _{SS}	Supply current		_	100	mA
P _{tot}	Total power dissipation			200	mW
T _{stg}	Storage temperature range		-65	+150	°C
T _{amb}	Operating ambient temperature		-40	+85	°C

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is desirable to take precautions appropriate to handling MOS devices. Advice can be found in Data Handbook IC24 under "Handling MOS devices".

DC CHARACTERISTICS

 V_{DD} = 2.3 to 5.5 V; V_{SS} = 0 V; T_{amb} = –40 to +85 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Supplies						
V_{DD}	Supply voltage		2.3		5.5	V
I _{DD}	Supply current	Operating mode; $V_{DD} = 5.5 \text{ V}$; no load; $f_{SCL} = 100 \text{ kHz}$	_	104	175	μΑ
I _{stbl}	Standby current	Standby mode; $V_{DD} = 5.5 \text{ V}$; no load; $V_{I} = V_{SS}$; $f_{SCL} = 0 \text{ kHz}$; $I/O = \text{inputs}$	_	550	700	μΑ
I _{stbh}	Standby current	Standby mode; V_{DD} = 5.5 V; no load; V_{I} = V_{DD} ; f_{SCL} = 0 kHz; I/O = inputs	_	0.25	1	μΑ
V_{POR}	Power-on reset voltage	No load; V _I = V _{DD} or V _{SS}	-	1.5	1.65	V
nput SCL;	input/output SDA	•				
V _{IL}	LOW level input voltage		-0.5	_	0.3 V _{DD}	V
V _{IH}	HIGH level input voltage		0.7 V _{DD}	_	5.5	V
I _{OL}	LOW level output current	V _{OL} = 0.4V	3	_		mA
ΙL	Leakage current	$V_I = V_{DD} = V_{SS}$	-1	_	+1	μΑ
C _I	Input capacitance	$V_I = V_{SS}$	<u> </u>	6	10	pF
I/Os		•				•
V _{IL}	LOW level input voltage		-0.5	_	0.8	V
V _{IH}	HIGH level input voltage		2.0	_	5.5	V
		V _{OL} = 0.5 V; V _{DD} = 2.3 V; Note 1	8	10	_	mA
		V _{OL} = 0.7 V; V _{DD} = 2.3 V; Note 1	10	13	_	mA
		V _{OL} = 0.5 V; V _{DD} = 4.5 V; Note 1	8	17	_	mA
I _{OL}	LOW level output current	V _{OL} = 0.7 V; V _{DD} = 4.5 V; Note 1	10	24		mA
		V _{OL} = 0.5 V; V _{DD} = 3.0 V; Note 1	8	14	_	mA
		V _{OL} = 0.7 V; V _{DD} = 3.0 V; Note 1	10	19		mA
		I _{OH} = -8 mA; V _{DD} = 2.3 V; Note 2	1.8	_	l –	V
		$I_{OH} = -10 \text{ mA}; V_{DD} = 2.3 \text{ V}; \text{ Note 2}$	1.7	_	_	V
	LHQLL laved autout walks as	$I_{OH} = -8 \text{ mA}; V_{DD} = 3.0 \text{ V}; \text{ Note 2}$	2.6	_		V
V _{OH}	HIGH level output voltage	$I_{OH} = -10 \text{ mA}; V_{DD} = 3.0 \text{ V}; \text{ Note 2}$	2.5	_	l –	V
		$I_{OH} = -8 \text{ mA}; V_{DD} = 4.75 \text{ V}; \text{ Note 2}$	4.1	_	_	V
		$I_{OH} = -10 \text{ mA}; V_{DD} = 4.75 \text{ V}; \text{ Note 2}$	4.0	_	_	V
I _{IH}	Input leakage current	$V_{DD} = 3.6 \text{ V}; V_{I} = V_{DD}$	-	_	1	μΑ
I _{IL}	Input leakage current	V _{DD} = 5.5 V; V _I = V _{SS}	-	_	-100	μΑ
C _I	Input capacitance			3.7	5	pF
Co	Output capacitance		_	3.7	5	pF
Interrupt IN	. T	<u> </u>				•
I _{OL}	LOW level output current	V _{OL} = 0.4 V	3	_	1 –	mA
	ts A0, A1, A2	1 ==				
V _{IL}	LOW level input voltage		-0.5	_	0.8	V
V _{IH}	HIGH level input voltage		2.0	_	5.5	V
ILI	Input leakage current		-1	_	1	μА

NOTES:

- 1. The total current sunk by all I/Os must be limited to 100 mA.
- 2. The total current sourced by all I/Os must be limited to 85 mA.

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

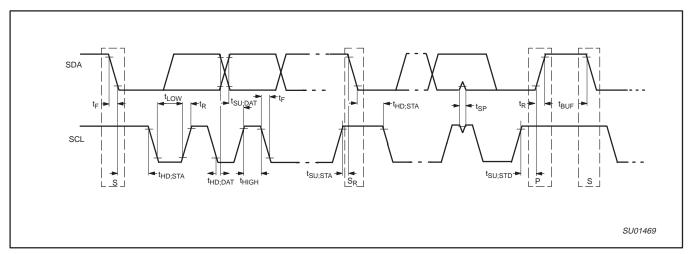


Figure 11. Definition of timing

AC SPECIFICATIONS

SYMBOL	PARAMETER		RD MODE BUS	FAST MO I ² C BU		UNITS
		MIN	MAX	MIN	MAX	
f _{SCL}	Operating frequency	0	100	0	400	kHz
t _{BUF}	Bus free time between STOP and START conditions	4.7	_	1.3	_	μs
t _{HD;STA}	Hold time after (repeated) START condition	4.0	_	0.6	_	μs
t _{SU;STA}	Repeated START condition setup time	4.7	_	0.6	_	μs
t _{SU;STO}	Setup time for STOP condition	4.0	_	0.6	_	μs
t _{HD;DAT}	Data in hold time	0	_	0	_	ns
t _{VD;ACK}	Valid time for ACK condition ²	0.3	3.45	0.1	0.9	μs
t _{VD;DAT}	Data out valid time ³	300	-	50	_	ns
t _{SU;DAT}	Data setup time	250	_	100	_	ns
t _{LOW}	Clock LOW period	4.7	_	1.3	_	μs
tHIGH	Clock HIGH period	4.0	_	0.6	_	μs
t _F	Clock/Data fall time	_	300	20 + 0.1 C _b ¹	300	ns
t _R	Clock/Data rise time	_	1000	20 + 0.1 C _b ¹	300	ns
t _{SP}	Pulse width of spikes that must be suppressed by the input filters	_	50	_	50	ns
Port Timing						
t _{PV}	Output data valid	_	200	_	200	ns
t _{PS}	Input data setup time	100	_	100	_	ns
t _{PH}	Input data hold time	1	_	1	_	μs
Interrupt Tim	ing					
t _{IV}	Interrupt valid	_	4		4	μs
t _{IR}	Interrupt reset	_	4	_	4	μs

NOTES:

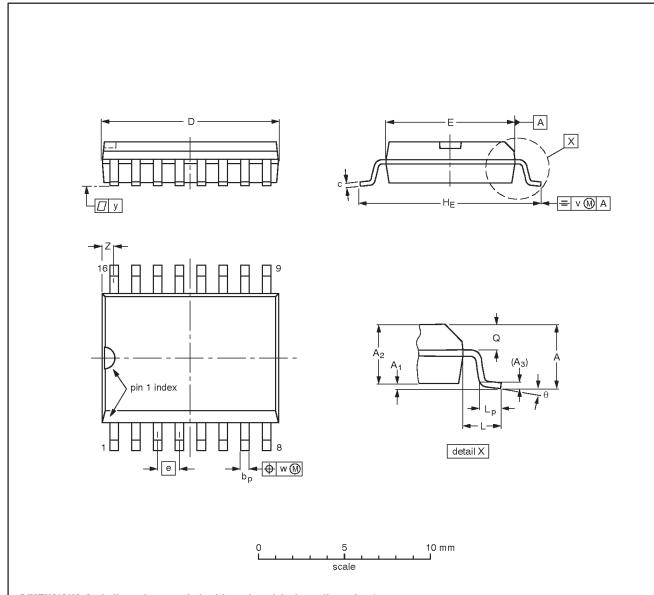
- C_b = total capacitance of one bus line in pF.
 t_{VD;ACK} = time for Acknowledgement signal from SCL low to SDA (out) low.
 t_{VD;DAT} = minimum time for SDA data out to be valid following SCL low.

8-bit I^2C and SMBus I/O port with interrupt

PCA9554/PCA9554A

SO16: plastic small outline package; 16 leads; body width 7.5 mm

SOT162-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	10.5 10.1	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.41 0.40	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016		0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

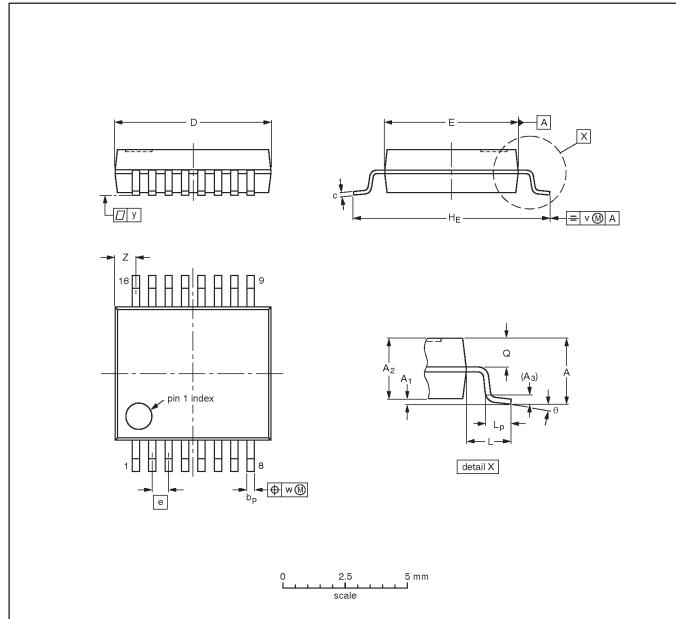
OUTLINE		REFER	ENCES	EUROPEAN	ICCUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT162-1	075E03	MS-013			-97-05-22 99-12-27

8-bit I^2C and SMBus I/O port with interrupt

PCA9554/PCA9554A

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

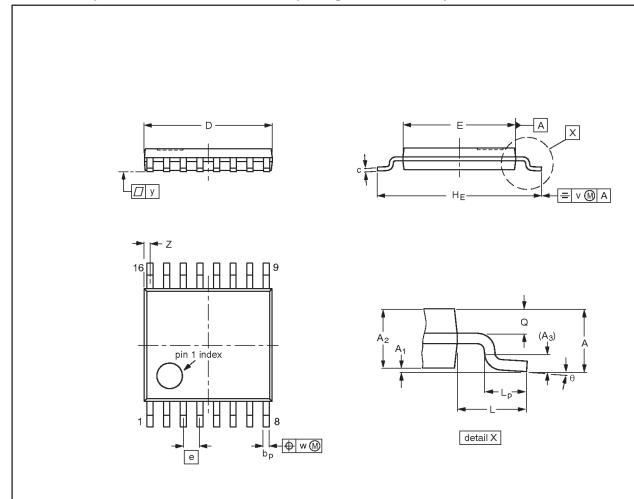
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VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT338-1		MO-150				95-02-04 99-12-27	

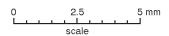
8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1





DIMENSIONS (mm are the original dimensions)

UI	III	A max.	A ₁	A ₂	A ₃	bр	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
m	m	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

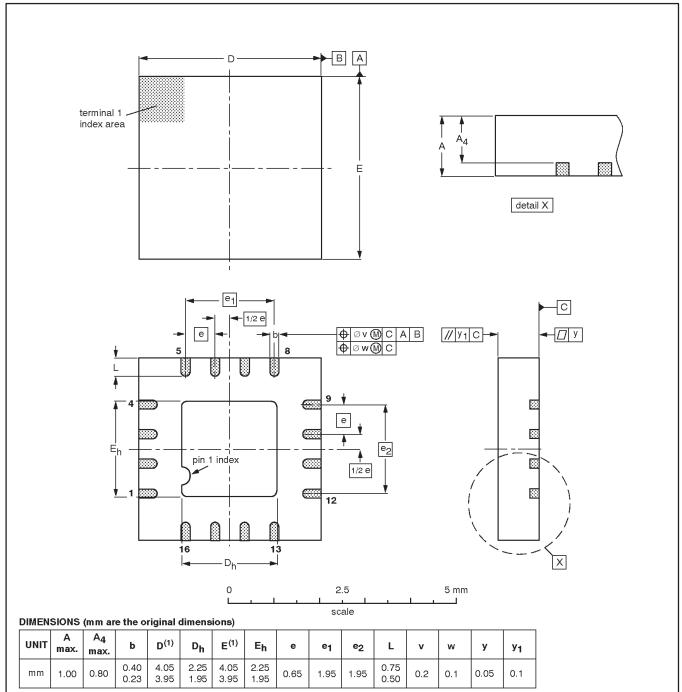
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VERSION	IEC	JEDEC	EIAJ		PROJECTION	1550E DATE	
SOT403-1		MO-153				-95-04-04 99-12-27	

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A

HVQFN16: plastic heatsink very thin quad flat package; no leads; 16 terminals; body $4 \times 4 \times 0.85 \text{ mm}$

SOT629-1



Note

1. Plastic or metal protrusions of 0.076 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE	
SOT629-1		MO-220				-01-06-28 01-08-08	

8-bit I²C and SMBus I/O port with interrupt

PCA9554/PCA9554A



Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specifications defined by Philips. This specification can be ordered using the code 9398 393 40011.

Data sheet status

Data sheet status ^[1]	Product status ^[2]	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

^[1] Please consult the most recently issued data sheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

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^[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.